

8A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

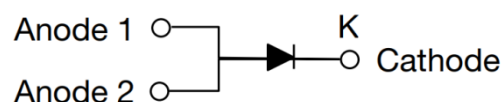
MECHANICAL DATA

- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.104g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	8	A
V_{RRM}	200 - 1000	V
I_{FSM}	230	A
$T_{J\ MAX}$	150	°C
Package	TO-277A (SMPC4.6U)	
Configuration	Single die	



TO-277A (SMPC4.6U)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	TUAS8D	TUAS8G	TUAS8J	TUAS8K	TUAS8M	UNIT
Marking code on the device			AS8D	AS8G	AS8J	AS8K	AS8M	
Repetitive peak reverse voltage		V _{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		V _{R(RMS)}	140	280	420	560	700	V
Forward current		I _F	8					A
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	I _{FSM}	230					A
	t = 1.0ms		580					A
Junction temperature		T _J	-55 to +150					°C
Storage temperature		T _{STG}	-55 to +150					°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	4	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	38	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	8	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	TUAS8D TUAS8G TUAS8J	I _F = 4A, T _J = 25°C	V _F	0.90	-	V
		I _F = 8A, T _J = 25°C		0.96	1.10	V
		I _F = 4A, T _J = 125°C		0.78	-	V
		I _F = 8A, T _J = 125°C		0.87	1.01	V
	TUAS8K TUAS8M	I _F = 4A, T _J = 25°C		0.90	-	V
		I _F = 8A, T _J = 25°C		0.97	1.10	V
		I _F = 4A, T _J = 125°C		0.78	-	V
		I _F = 8A, T _J = 125°C		0.87	1.01	V
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	I _R	-	5	μA
		T _J = 125°C		-	60	μA
Junction capacitance	TUAS8D TUAS8G TUAS8J	1MHZ, V _R = 4.0V	C _J	62	-	pF
	TUAS8K TUAS8M			54	-	pF

Notes:

- Pulse test with $PW = 0.3\text{ms}$
- Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
TUAS8x	TO-277A (SMPC4.6U)	6,000 / Tape & Reel

Notes:

- "x" defines voltage from 200V(TUAS8D) to 1000V(TUAS8M)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

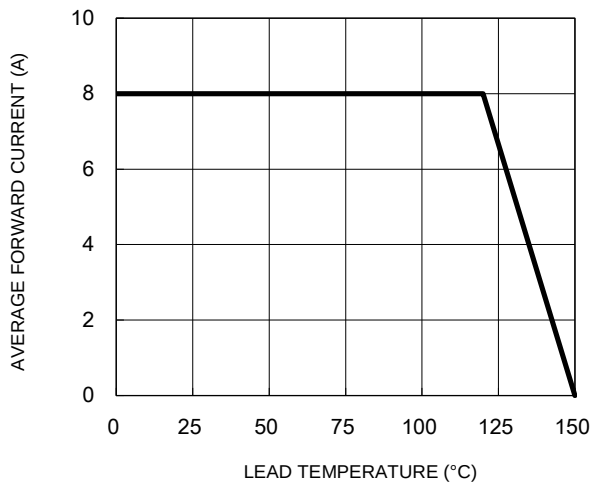


Fig.2 Typical Junction Capacitance

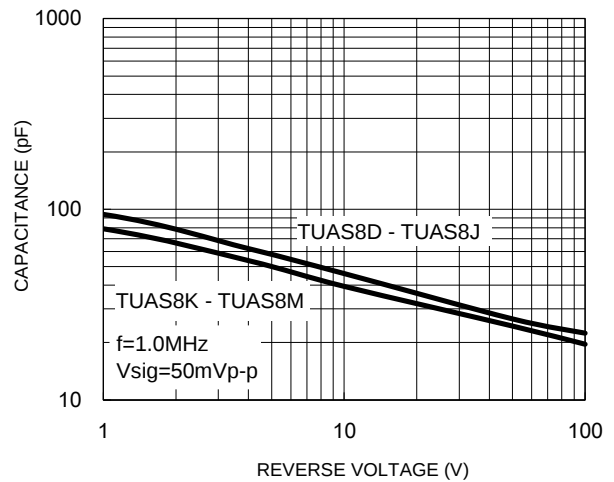


Fig.3 Typical Reverse Characteristics

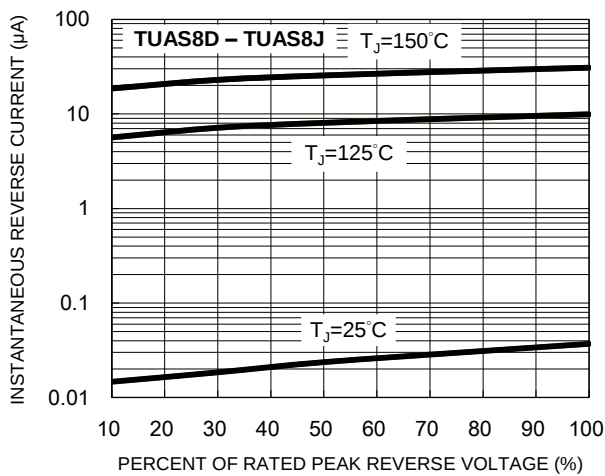


Fig.4 Typical Forward Characteristics

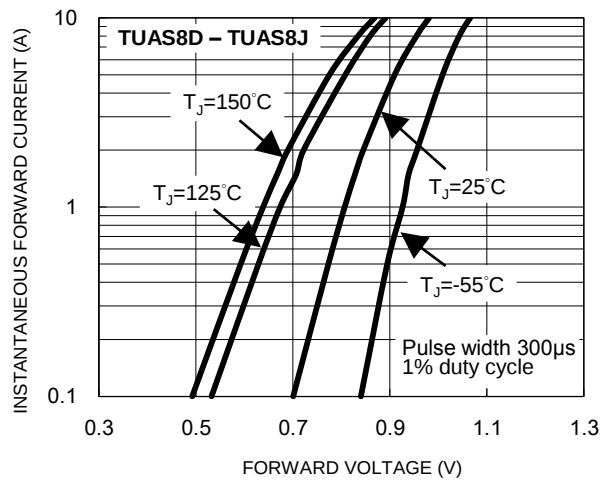


Fig.5 Typical Reverse Characteristics

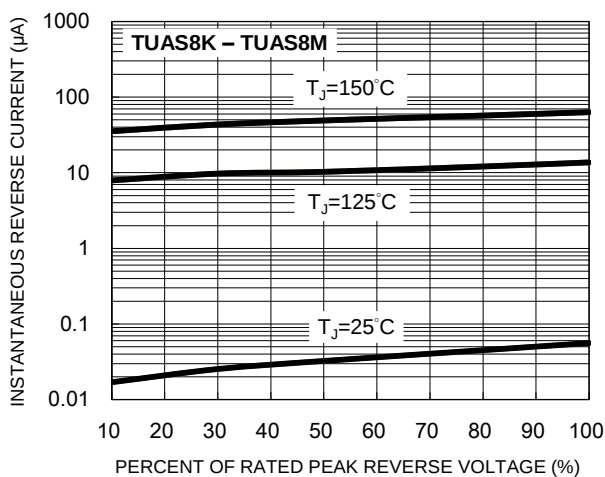
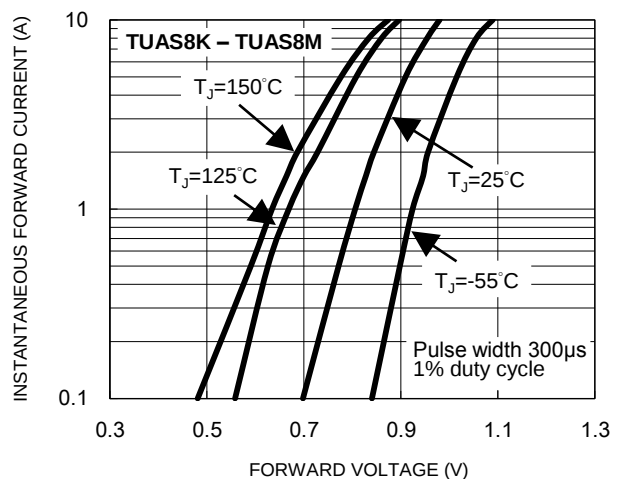


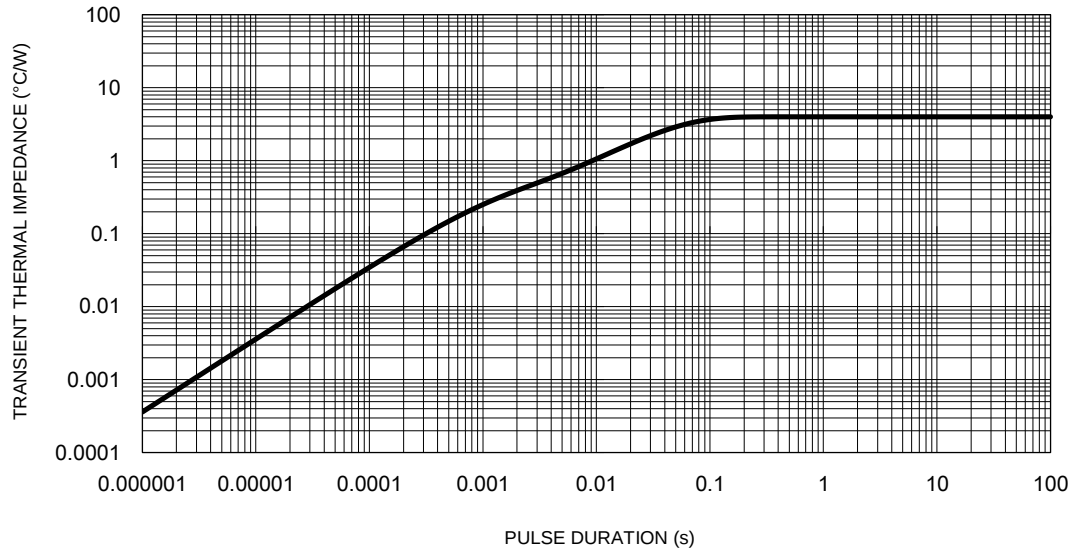
Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

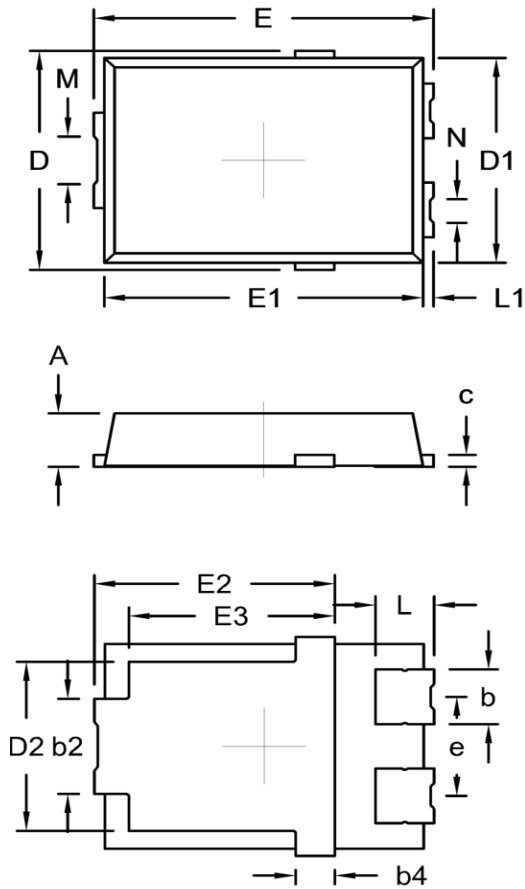
($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS

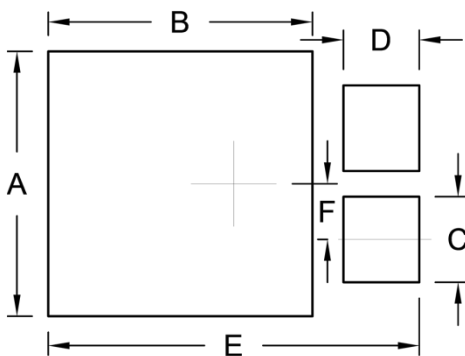
TO-277A (SMPC4.6U)



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (NOM.)		0.030 (NOM.)	
c	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)		0.155 (NOM.)	
e	2.08 (NOM.)		0.082 (NOM.)	
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
M	0.65	1.15	0.026	0.045
N	0.25	0.75	0.010	0.030

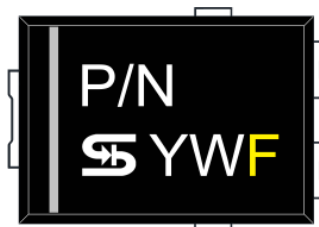
Package body size D1 and E1 do not include mold flash
 Mold flash shall not exceed 0.1mm per side

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	4.95	0.195
B	4.95	0.195
C	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

MARKING DIAGRAM



P/N = Marking Code
 YW = Date Code
 F = Factory Code

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